Unit: mm

TOSHIBA Field Effect Transistor Silicon N-Channel MOS Type

SSM3K15CT

High-Speed Switching Applications Analog Switch Applications

- Optimum for high-density mounting in small packages
- Low ON-resistance
 - : $R_{on} = 4.0 \Omega \text{ (max) } (@V_{GS} = 4 \text{ V})$
 - : $R_{on} = 7.0 \Omega \text{ (max) } (@V_{GS} = 2.5 \text{ V})$

Absolute Maximum Ratings (Ta = 25°C)

| Characteristics | | Symbol | Rating | Unit | |
|-------------------------------------|-------|-------------------------|------------|---------------------|--|
| Drain-source voltage | | V_{DS} | 30 | Z X | |
| Gate-source voltage | | V_{GSS} | ±20 | $(\bigvee \bigvee)$ | |
| Drain current | DC | ΙD | 100 | mA | |
| | Pulse | I _{DP} | 200 | | |
| Drain power dissipation (Ta = 25°C) | | P _D (Note 1) | 100 | → mW | |
| Channel temperature | | T _{ch} | 150 | °C | |
| Storage temperature | | T _{stg} | _55 to 150 | °C | |

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling

Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Mounted on an FR4 board

 $(10 \text{ mm} \times 10 \text{ mm} \times 1.0 \text{ t, Cu Pad: } 100 \text{ mm}^2)$

JEDEC JEITA TOSHIBA 2-1J1B Weight: 0.75 mg (typ.) data (i.e. reliability test report and

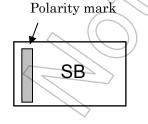
0.5 ±0.05

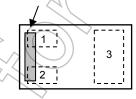
BOTTOM VIEW

Marking (Top View)

Pin Condition (Top View)

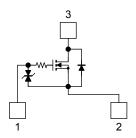
Polarity mark (on the top)





- 1. Gate
- 2. Source
- 3. Drain
- *Electrodes: On the bottom

Equivalent Circuit



Handling Precaution

When handling individual devices that are not yet mounted on a circuit board, ensure that the environment is protected against electrostatic discharge. Operators should wear anti-static clothing, and containers and other objects that come into direct contact with devices should be made of anti-static materials.

Start of commercial production 2004-08

90%

toff

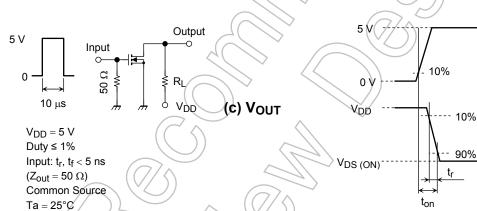
Electrical Characteristics (Ta = 25°C)

| Characteristics | | Symbol | Test Condition | Min | Тур. | Max | Unit |
|----------------------------|----------------|----------------------|---|-------|------|---------------|------|
| Gate leakage current | | I _{GSS} | $V_{GS} = \pm 16 \text{ V}, V_{DS} = 0$ | _ | _ | ±1 | μА |
| Drain-source brea | akdown voltage | V (BR) DSS | $I_D = 0.1 \text{ mA}, V_{GS} = 0$ | 30 | _ | _ | V |
| Drain cut-off curre | ent | I _{DSS} | V _{DS} = 30 V, V _{GS} = 0 | | _ | 1 | μА |
| Gate threshold vo | oltage | V _{th} | V _{DS} = 3 V, I _D = 0.1 mA | 0.8 | _ | 1.5 | V |
| Forward transfer | admittance | Y _{fs} | $V_{DS} = 3 \text{ V}, I_D = 10 \text{ mA}$ | 25 |)> | _ | mS |
| Drain-Source ON-resistance | | R _{DS} (ON) | I _D = 10 mA, V _{GS} = 4 V | ,) ^ | 2.2 | 4.0 | Ω |
| | | | I _D = 10 mA, V _{GS} = 2.5 V | ()) | 4.0 | 7.0 | |
| Input capacitance | | C _{iss} | V _{DS} = 3 V, V _{GS} = 0, f = 1 MHz | _ | 7.8 | _ | pF |
| Reverse transfer | capacitance | C _{rss} | V _{DS} = 3 V, V _{GS} = 0, f = 1 MHz | > _ | 3.6 | _ | pF |
| Output capacitano | ce | Coss | V _{DS} = 3 V, V _{GS} = 0, f = 1 MHz | _ | 8.8 | _ | pF |
| Switching time | Turn-on time | t _{on} | V 5V I- 10 mA V 0 to 5 V | _ | 50 | \rightarrow | ns |
| | Turn-off time | t _{off} | $V_{DD} = 5 \text{ V}, I_D = 10 \text{ mA}, V_{GS} = 0 \text{ to } 5 \text{ V}$ | -/ | 180 | > — | |

Switching Time Test Circuit





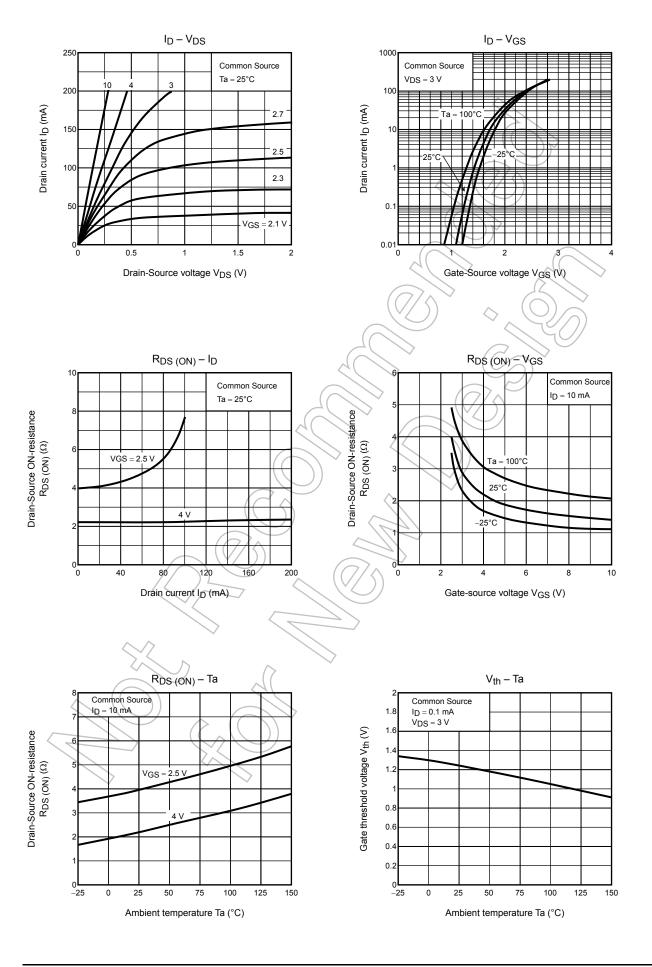


Precaution

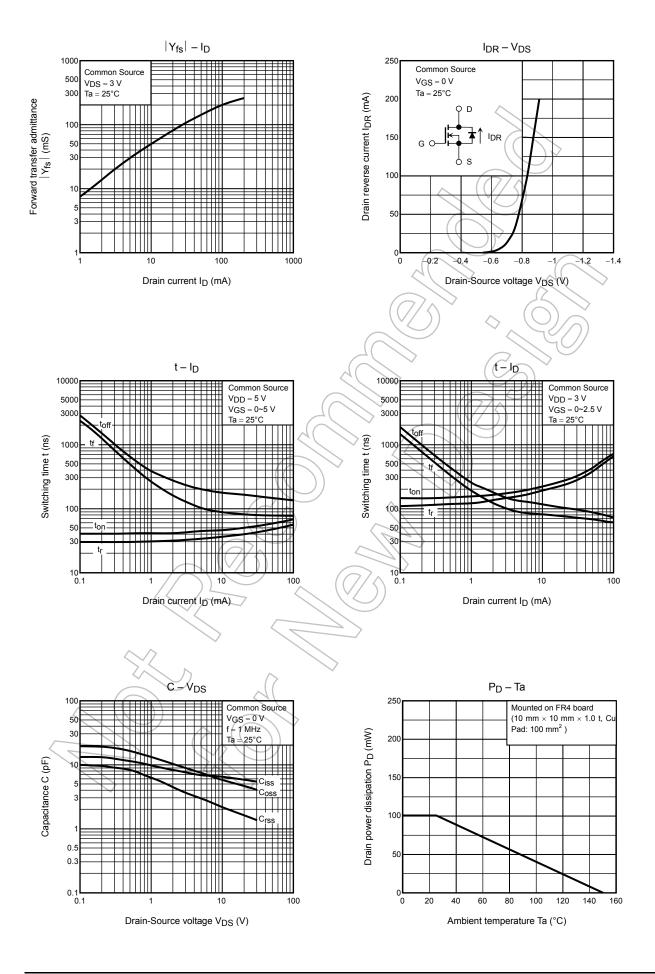
 V_{th} can be expressed as the voltage between gate and source when the low operating current value is I_D = 100 μ A for this product. For normal switching operation, V_{GS} (on) requires a higher voltage than V_{th} and V_{GS} (off) requires a lower voltage than V_{th} . (The relationship can be established as follows: V_{GS} (off) < V_{th} < V_{GS} (on).)

Take this into consideration when using the device.





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